SCLS134B - DECEMBER 1982 - REVISED MAY 1997

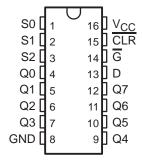
- 8-Bit Parallel-Out Storage Register Performs Serial-to-Parallel Conversion With Storage
- Asynchronous Parallel Clear
- Active-High Decoder
- Enable Input Simplifies Expansion
- Expandable for n-Bit Applications
- Four Distinct Functional Modes
- Package Options Include Plastic Small-Outline (D), Thin Shrink Small-Outline (PW), and Ceramic Flat (W) Packages, Ceramic Chip Carriers (FK), and Standard Plastic (N) and Ceramic (J) 300-mil DIPs

#### description

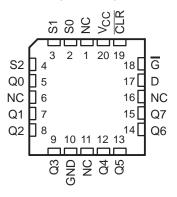
These 8-bit addressable latches are designed for general-purpose storage applications in digital systems. Specific uses include working registers, serial-holding registers, and active-high decoders or demultiplexers. They are multifunctional devices capable of storing single-line data in eight addressable latches, and being a 1-of-8 decoder or demultiplexer with active-high outputs.

Four distinct modes of operation are selectable by controlling the clear ( $\overline{CLR}$ ) and enable ( $\overline{G}$ ) inputs. In the addressable-latch mode, data at the data-in terminal is written into the addressed latch. The addressed latch follows the data input with all unaddressed latches remaining in their previous states. In the memory mode, all latches remain in their previous states and are unaffected by the data or address inputs. To eliminate the possibility of entering erroneous data in the latches,  $\overline{G}$ should be held high (inactive) while the address lines are changing. In the 1-of-8 decoding or demultiplexing mode, the addressed output follows the level of the D input with all other outputs low. In the clear mode, all outputs are low and unaffected by the address and data inputs.

SN54HC259 . . . J OR W PACKAGE SN74HC259 . . . D, N, OR PW PACKAGE (TOP VIEW)



SN54HC259 . . . FK PACKAGE (TOP VIEW)



NC - No internal connection

The SN54HC259 is characterized for operation over the full military temperature range of –55°C to 125°C. The SN74HC259 is characterized for operation from –40°C to 85°C.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.



## **Function Tables**

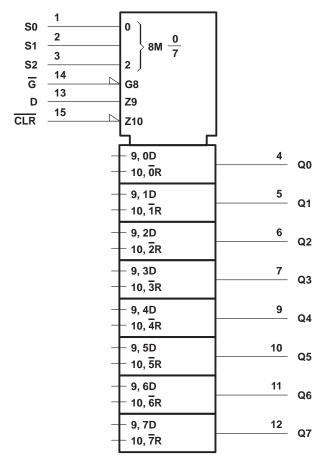
## **FUNCTION**

INPL	JTS	OUTPUT OF ADDRESSED	EACH OTHER	FUNCTION			
CLR	G	LATCH	OUTPUT	FUNCTION			
Н	L	D	Q <sub>iO</sub>	Addressable latch			
Н	Н	Q <sub>iO</sub>	$Q_{iO}$	Memory			
L	L	D	L	8-line demultiplexer			
L	Н	L	L	Clear			

#### LATCH SELECTION

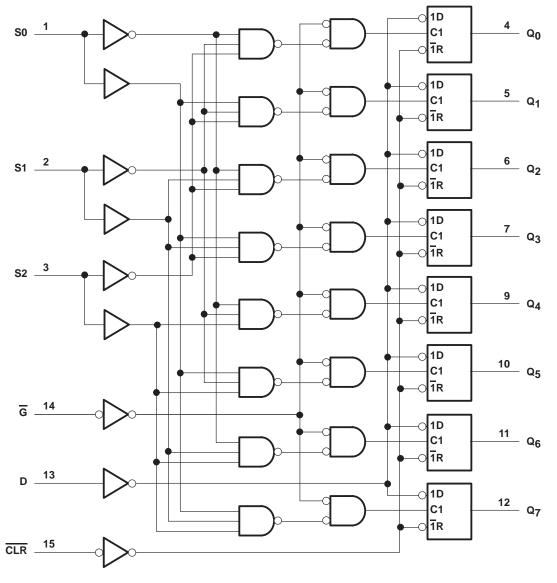
SEL	ECT INF	LATCH	
S2	<b>S</b> 1	S0	ADDRESSED
L	L	L	0
L	L	Н	1
L	Н	L	2
L	Н	Н	3
Н	L	L	4
Н	L	Н	5
Н	Н	L	6
Н	Н	Н	7

## logic symbol†



<sup>†</sup> This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12. Pin numbers shown are for the D, J, N, PW, and W packages.

## logic diagram (positive logic)

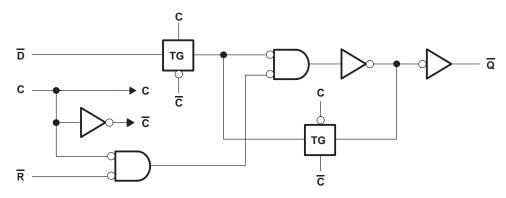


Pin numbers shown are for the D, J, N, PW, and W packages.

## logic symbol, each internal latch



## logic diagram, each internal latch (positive logic)



## absolute maximum ratings over operating free-air temperature range<sup>†</sup>

Supply voltage range, V <sub>CC</sub>		0.5 V to 7 V
Input clamp current, $I_{IK}$ ( $V_I < 0$ or $V_I > V_{CC}$ ) (see	ee Note 1)	±20 mA
Output clamp current, IOK (VO < 0 or VO > VCO	c) (see Note 1)	±20 mA
Continuous output current, $I_O$ ( $V_O = 0$ to $V_{CC}$ )	- 	±25 mA
Continuous current through V <sub>CC</sub> or GND		±50 mA
Package thermal impedance, θ <sub>JA</sub> (see Note 2):		
	N package	78°C/W
	PW package	149°C/W
Storage temperature range, T <sub>stg</sub>		

<sup>†</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.
  - 2. The package thermal impedance is calculated in accordance with JESD 51, except for through-hole packages, which use a trace length of zero.

## SN54HC259, SN74HC259 8-BIT ADDRESSABLE LATCHES

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## recommended operating conditions

			SI	154HC25	i9	SN	174HC25	i9	UNIT
			MIN	NOM	MAX	MIN	NOM	MAX	UNII
Vcc	Supply voltage		2	5	6	2	5	6	V
		V <sub>CC</sub> = 2 V	1.5			1.5			
VIH	High-level input voltage	V <sub>CC</sub> = 4.5 V	3.15			3.15			V
		VCC = 6 V	4.2			4.2			
		V <sub>CC</sub> = 2 V	0		0.5	0		0.5	
VIL	Low-level input voltage	V <sub>CC</sub> = 4.5 V	0		1.35	0		1.35	V
		VCC = 6 V	0		1.8	0		6 0.5	
٧ı	Input voltage		0		VCC	0		VCC	V
Vo	Output voltage		0		VCC	0		VCC	V
		V <sub>CC</sub> = 2 V	0		1000	0		1000	
t <sub>t</sub>	Input transition (rise and fall) time	V <sub>CC</sub> = 4.5 V	0		500	0		500	ns
		V <sub>CC</sub> = 6 V	0		400	0		0.5 1.35 1.8 VCC VCC 1000 500 400	
TA	Operating free-air temperature	_	-55		125	-40		85	°C

# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

DADAMETED	TEST CONDITIONS		V	T <sub>A</sub> = 25°C			SN54HC259		SN74HC259		UNIT
PARAMETER			vcc	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNII
			2 V	1.9	1.998		1.9		1.9		
		$I_{OH} = -20  \mu A$	4.5 V	4.4	4.499		4.4		4.4		
VOH	VI = VIH or VIL		6 V	5.9	5.999		5.9		5.9		V
		$I_{OH} = -4 \text{ mA}$	4.5 V	3.98	4.3		3.7		3.84		
		$I_{OH} = -5.2 \text{ mA}$	6 V	5.48	5.8		5.2		5.34		
	VI = VIH or VIL	I <sub>OL</sub> = 20 μA	2 V		0.002	0.1		0.1		0.1	V
			4.5 V		0.001	0.1		0.1		0.1	
VOL			6 V		0.001	0.1		0.1		0.1	
		$I_{OL} = 4 \text{ mA}$	4.5 V		0.17	0.26		0.4		0.33	
		$I_{OL} = 5.2 \text{ mA}$	6 V		0.15	0.26		0.4		0.33	
lį	$V_I = V_{CC}$ or 0		6 V		±0.1	±100		±1000		±1000	nA
Icc	$V_I = V_{CC}$ or 0,	I <sub>O</sub> = 0	6 V			8		160		80	μΑ
C <sub>i</sub>			2 V to 6 V		3	10		10		10	pF

## timing requirements over recommended operating free-air temperature range (unless otherwise noted)

			vcc		25°C	SN54F	IC259	SN74H	IC259	UNIT
			\ vcc	MIN	MAX	MIN	MAX	MIN	MAX	UNII
t <sub>W</sub> Pulse			2 V	80		120		100		
		CLR low	4.5 V	16		24		20		
	Pulse duration		6 V	14		20		17		ns
	ruise duration		2 V	80		120		100		
		G low	4.5 V	16		24		20		
			6 V	14		20		17		
			2 V	75		115		95		
t <sub>su</sub>	Setup time, data or address before $\overline{G} \!\!\uparrow$		4.5 V	15		23		19		ns
			6 V	13		20		16		
			2 V	5		5		5		
t <sub>h</sub> Hold time, data or address after G↑			4.5 V	5		5		5		ns
			6 V	5		5		5		

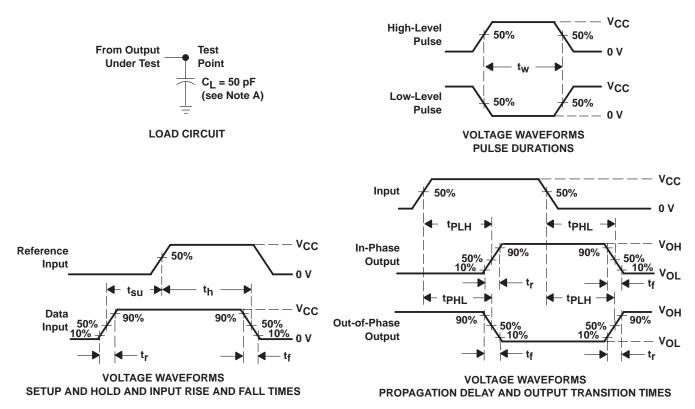
## switching characteristics over recommended operating free-air temperature range, $C_L$ = 50 pF (unless otherwise noted) (see Figure 1)

DADAMETED	FROM	то	Vaa	T,	ղ = 25°C	;	SN54H	IC259	SN74H	IC259	LINIT		
PARAMETER	(INPUT)	(OUTPUT)	VCC	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNIT		
			2 V		60	150		225		190			
t <sub>PHL</sub>	CLR	Any Q	4.5 V		18	30		45		38	ns		
			6 V		14	26		38		32			
			2 V		56	130		195		165			
	Data	Any Q	4.5 V		17	26		39		33	ns		
			6 V		13	22		33		28			
		Any Q	2 V		74	200		300		250			
<sup>t</sup> pd	Address		4.5 V		21	40		60		50			
			6 V		17	34		51		43			
		Any Q	2 V		66	170		255		215			
	G		4.5 V		20	34		51		43			
			6 V		16	29		43		37			
			2 V		28	75		110		95			
t <sub>t</sub>		Any	Any	Any	4.5 V		8	15		22		19	ns
			6 V		6	13		19		16			

## operating characteristics, $T_A = 25^{\circ}C$

	PARAMETER	TEST CONDITIONS	TYP	UNIT
C <sub>pd</sub>	Power dissipation capacitance per latch	No load	33	pF

#### PARAMETER MEASUREMENT INFORMATION



NOTES: A. C<sub>L</sub> includes probe and test-fixture capacitance.

- B. Phase relationships between waveforms were chosen arbitrarily. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  1 MHz,  $Z_O = 50 \ \Omega$ ,  $t_r = 6 \ ns$ ,  $t_f = 6 \ ns$ .
- C. The outputs are measured one at a time with one input transition per measurement.
- D. tpLH and tpHL are the same as tpd.

Figure 1. Load Circuit and Voltage Waveforms



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